3.3 V, 133.33 MHz /137.93 MHz Dual Frequency CML Clock Oscillator

The NBXDDB016/NBXDDA016 dual frequency crystal oscillator (XO) is designed to meet today's requirements for 3.3 V CML clock generation applications. The device uses a high Q fundamental crystal and Phase Lock Loop (PLL) multiplier to provide selectable 133.33 MHz or 137.93 MHz, ultra low jitter and phase noise CML differential output.

This device is a member of ON Semiconductor's PureEdge^m clock family that provides accurate and precision clock solutions.

Available in 5 mm x 7 mm SMD (CLCC) package on 16 mm tape and reel in quantities of 1,000. Frequency stability options available as either 50 PPM NBXDDB016 or 20 PPM NBXDDA016.

Features

- CML Differential Output
- Uses High Q Fundamental Mode Crystal and PLL Multiplier
- Ultra Low Jitter and Phase Noise 0.4 ps (12 kHz 20 MHz)
- Selectable Output Frequency 133.33 MHz (default)/137.93 MHz
- Hermetically Sealed Ceramic SMD Package
- RoHS Compliant
- Operating Range 3.3 V ±10%
- Total Frequency Stability ±20 PPM or ±50 PPM

Applications

- High-End Servers
- Basestation
- General Purpose Clock Generation and Margining

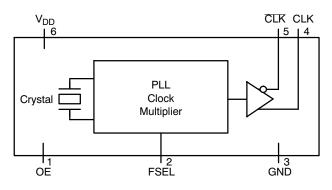


Figure 1. Simplified Logic Diagram



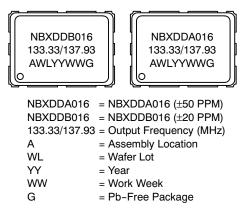
ON Semiconductor®

http://onsemi.com



6 PIN CLCC LN SUFFIX CASE 848AB

MARKING DIAGRAMS



ORDERING INFORMATION

Device	Package	Shipping†
NBXDDB016LN1TAG*	CLCC-6 (Pb-Free)	1000/ Tape & Reel
NBXDDA016LN1TAG	CLCC-6 (Pb-Free)	1000/ Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

* Please contact sales office for availability

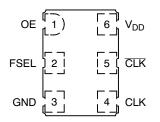


Figure 2. Pin Connections (Top View)

Table 1. PIN DESCRIPTION

Pin No.	Symbol	I/O	Description
1	OE	LVTTL/LVCMOS Control Input	Output Enable Pin. When left floating pin defaults to logic HIGH and output is active. See OE pin description Table 2.
2	FSEL	Control Input	Output Frequency Select Pin. Pin will default LOW when left open. See Output Fre- quency Select Table 3.
3	GND	Power Supply	Ground 0 V.
4	CLK	CML Output	Non–Inverted Clock Output. Typically loaded with 50 Ω receiver termination resistor to V_{TT} = $V_{DD}.$
5	CLK	CML Output	Inverted Clock Output. Typically loaded with 50 Ω receiver termination resistor to V_{TT} = $V_{DD}.$
6	V _{DD}	Power Supply	Positive power supply voltage. Voltage should not exceed 3.3 V $\pm 10\%$.

Table 2. OUTPUT ENABLE TRI-STATE FUNCTION

OE Pin	Output Pins
Open	Active
High Level	Active
Low Level	High Z

Table 3. OUTPUT FREQUENCY SELECT

FSEL Pin	Output Frequency (MHz)
Open (pin will float Low)	133.33
High Level	137.93
Low Level	133.33

Table 4. ATTRIBUTES

Characteristic		Value	
Input Default State Resistor		170 kΩ	
ESD Protection Human Body Model Machine Model		2 kV 200 V	
Meets or Exceeds JEDEC Standard EIA/JESD78 IC Latchup Test			

1. For additional Moisture Sensitivity information, refer to Application Note AND8003/D.

Table 5. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V _{DD}	Positive Power Supply	GND = 0 V		4.6	V
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-55 to +120	°C
T _{sol}	Wave Solder	See Figure 6		260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Symbol	Characteristic	Conditions	Min.	Тур.	Max.	Units
I _{DD}	Power Supply Current (Note 2)			70	100	mA
VIH	OE Input HIGH Voltage		2000		V _{DD}	mV
VIL	OE Input LOW Voltage		GND - 300		800	mV
IIН	Input HIGH Current OE FSEL		-100 -100		+100 +100	μΑ
Ι _{ΙL}	Input LOW Current OE FSEL		-100 -100		+100 +100	μΑ
V _{IH}	FSEL Input HIGH Voltage		2000		V _{DD}	mV
V _{IL}	FSEL Input LOW Voltage		0		800	mV
V _{OH}	Output HIGH Voltage (Note 2)		V _{DD} -40		V _{DD}	mV
V _{OL}	Output LOW Voltage (Note 2)		V _{DD} -450	V _{DD} -380	V _{DD} -300	mV
V _{OUTPP}	Output Voltage Amplitude (Note 2)			380		mV

Table 6. DC CHARACTERISTICS (V_{DD} = $3.3 \text{ V} \pm 10\%$, GND = 0 V, T_A = -40° C to $+85^{\circ}$ C) (Note 2)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

2. Measurement taken with outputs terminated with 50 ohm to $V_{\text{DD}}.$ See Figure 5.

Symbol	Characteristic	Conditions	Min.	Тур.	Max.	Units
fclkout	Output Clock Frequency	FSEL = HIGH		137.93		MHz
		FSEL = LOW		133.33		
Δf	Frequency Stability - NBXDDB016 - NBXDDA016	(Note 4)			±20 ±50	ppm
Φ_{NOISE}	Phase-Noise Performance	100 Hz of Carrier		-102		dBc/Hz
	f _{CLKout} = 133.33 MHz/137.93 MHz	1 kHz of Carrier		-120		dBc/Hz
	(See Figures 3 and 4)	10 kHz of Carrier		-126		dBc/Hz
		100 kHz of Carrier		-126		dBc/Hz
		1 MHz of Carrier		-134		dBc/Hz
		10 MHz of Carrier		-162		dBc/Hz
t _{jit} (Φ)	RMS Phase Jitter	12 kHz to 20 MHz		0.4	0.9	ps
t _{jitter}	Cycle to Cycle, RMS	1000 Cycles		1.5	8	ps
	Cycle to Cycle, Peak-to-Peak	1000 Cycles		10	30	ps
	Period, RMS	10,000 Cycles		0.8	4	ps
	Period, Peak-to-Peak	10,000 Cycles		7	20	ps
t _{OE/OD}	Output Enable/Disable Time				200	ns
^t DUTY_CYCLE	Output Clock Duty Cycle (Measured at Cross Point)		48	50	52	%
t _R	Output Rise Time (20% and 80%)			160	300	ps
t _F	Output Fall Time (80% and 20%)			160	300	ps
t _{start}	Start-up Time			1	5	ms
	Aging	1 st Year			3	ppm
		Every Year After 1st			1	ppm

Table 7. AC CHARACTERISTICS (V_DD = 3.3 V \pm 10%, GND = 0 V, T_A = -40°C to +85°C) (Note 3)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. Measurement taken with outputs terminated with 50 ohm to V_{DD} . See Figure 5.

4. Parameter guarantees 10 years of aging. Includes initial stability at 25°C, shock, vibration, and first year aging.

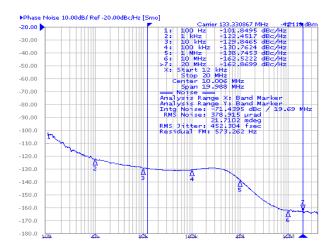


Figure 3. Typical Phase Noise Plot @ 133.33 MHz

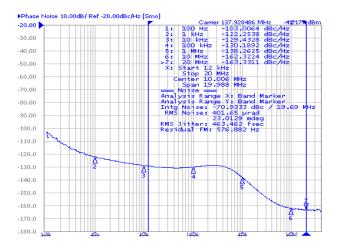
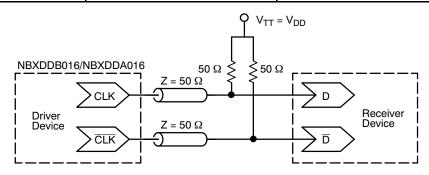
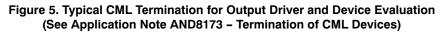


Figure 4. Typical Phase Noise Plot @ 137.93 MHz

Table 8. RELIABILITY COMPLIANCE

Parameter	Standard	Method
Shock	Mechanical	MIL-STD-833, Method 2002, Condition B
Solderability	Mechanical	MIL-STD-833, Method 2003
Vibration	Mechanical	MIL-STD-833, Method 2007, Condition A
Solvent Resistance	Mechanical	MIL-STD-202, Method 215
Thermal Shock	Environment	MIL-STD-833, Method 1011, Condition A
Moisture Level Sensitivity	Environment	MSL1 260°C per IPC/JEDEC J-STD-020D





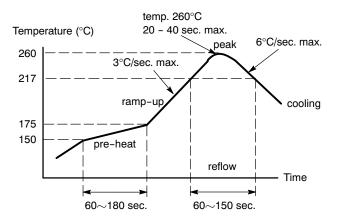
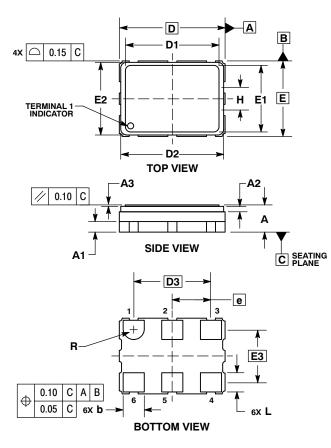


Figure 6. Recommended Reflow Soldering Profile

PACKAGE DIMENSIONS

6 PIN CLCC, 7x5, 2.54P CASE 848AB-01 ISSUE C

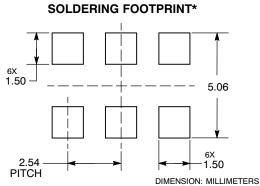


NOTES:

1. DIMENSIONING AND TOLERANCING PER

- ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	1.70	1.80	1.90	
A1		0.70 REF		
A2		0.36 REF		
A3	0.08	0.10	0.12	
b	1.30	1.40	1.50	
D	7.00 BSC			
D1	6.17	6.20	6.23	
D2	6.66	6.81	6.96	
D3	5.08 BSC			
E		5.00 BSC		
E1	4.37	4.40	4.43	
E2	4.65	4.80	4.95	
E3	3.49 BSC			
е	2.54 BSC			
Ĺ	1.17	1.27	1.37	
R	0.70 REF			



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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